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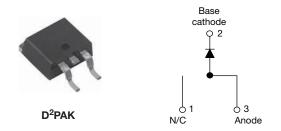
RoHS

COMPLIANT

HALOGEN

FREE

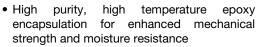
High Performance Schottky Rectifier, 15 A

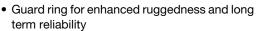


PRODUCT SUMMARY								
I _{F(AV)}	15 A							
V_{R}	35 V,40 V,45 V							
V _F at I _F	0.50 V							
I _{RM} max.	70 mA at 125 °C							
T _J max.	150 °C							
E _{AS}	16 mJ							
Package	TO-263AB (D ² PAK)							
Diode variation	Single die							

FEATURES

- 150 °C T_J operation
- Very low forward voltage drop
- High frequency operation





- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



The VS-12TQ...S-M3 Schottky rectifier series has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL CHARACTERISTICS VALUES									
I _{F(AV)}	Rectangular waveform	15	А						
V _{RRM}	Range	35 to 45	V						
I _{FSM}	t _p = 5 μs sine	990	А						
V _F	15 A _{pk} , T _J = 125 °C	0.50	V						
T _J	Range	-55 to 150	°C						

VOLTAGE RATINGS								
PARAMETER SYMBOL VS-12TQ035S-M3 VS-12TQ040S-M3 VS-12TQ045S-M3 UNIT								
Maximum DC reverse voltage	V_R	35	40	45	W			
Maximum working peak reverse voltage	V_{RWM}	33	40	45	V			

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDI	VALUES	UNITS				
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 120 °C	15	Α				
Maximum peak one cycle non-repetitive surge current	I	5 µs sine or 3 µs rect. pulse	Following any rated load condition and with	990	Α			
See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	250				
Non-repetitive avalanche energy	E _{AS}	T _J = 25 °C, I _{AS} = 2.4 A, L = 5.5 mH		16	mJ			
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		2.4	Α			



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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS				
		15 A	T _{.1} = 25 °C	0.56			
Maximum forward voltage drop	V _{FM} ⁽¹⁾	30 A	- IJ=25 C	0.71	.,		
See fig. 1		15 A	T 105 °C	0.50	V		
		30 A	- T _J = 125 °C	0.64			
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	1.75	mΛ		
See fig. 2		T _J = 125 °C	v _R = nateu v _R	70	- mA		
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz), 25 °C		900	рF		
Typical series inductance	L _S	Measured lead to lead 5 r	8.0	nH			
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs			

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and st temperature range	orage	T _J , T _{Stg}		-55 to 150	°C		
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	2.0	°C/W		
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50			
Approvimento veciclet				2	g		
Approximate weight				0.07	OZ.		
Marinting taxaria	minimum			6 (5)	kgf · cm		
Mounting torque	maximum			12 (10)	(lbf · in)		
Marking device			Case style D ² PAK		030S 044S 045S		

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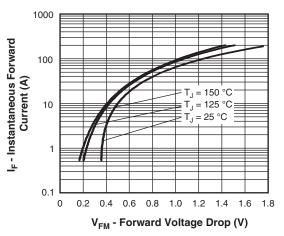


Fig. 1 - Maximum Forward Voltage Drop Characteristics

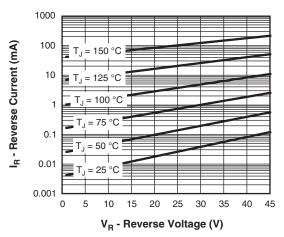


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

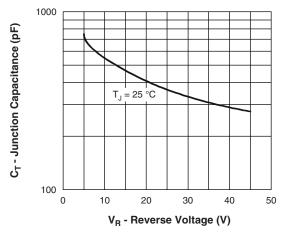


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

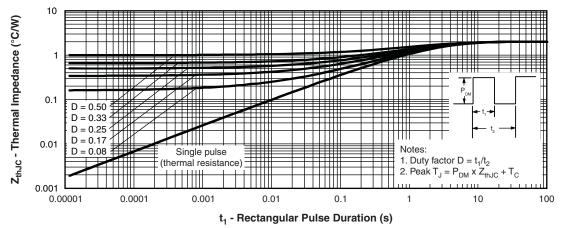


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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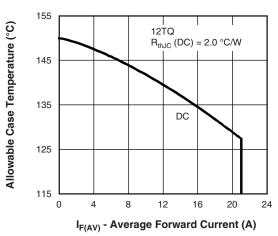


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

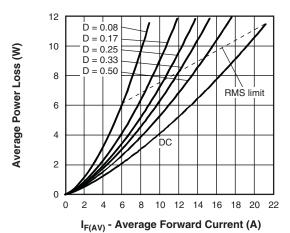


Fig. 6 - Forward Power Loss Characteristics

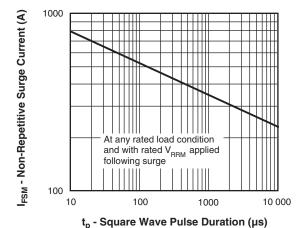


Fig. 7 - Maximum Non-Repetitive Surge Current

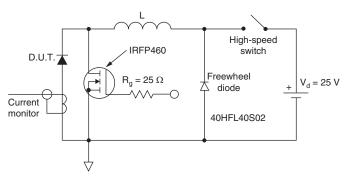
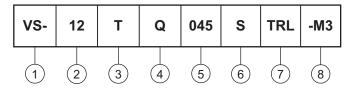


Fig. 8 - Unclamped Inductive Test Circuit

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating

- Package: T = TO-220

- Schottky "Q" series 035 = 35 V 040 = 40 V

6 - S = D²PAK

7 - • None = Tube

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

8 - -M3 = Halogen-free, RoHS-compliant and termination lead (Pb)-free

ORDERING INFORMATION									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-12TQ035S-M3	50	1000	Antistatic plastic tubes						
VS-12TQ035STRR-M3	800	800	13" diameter reel						
VS-12TQ035STRL-M3	800	800	13" diameter reel						
VS-12TQ040S-M3	50	1000	Antistatic plastic tubes						
VS-12TQ040STRR-M3	800	800	13" diameter reel						
VS-12TQ040STRL-M3	800	800	13" diameter reel						
VS-12TQ045S-M3	50	1000	Antistatic plastic tubes						
VS-12TQ045STRR-M3	800	800	13" diameter reel						
VS-12TQ045STRL-M3	800	800	13" diameter reel						

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95046					
Part marking information	www.vishay.com/doc?95444					
Packaging information	www.vishay.com/doc?95032					



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	ETERS	INC	HES	NOTES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES		STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

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